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# PC35H13 V1

**Product Specification** 

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## **Approval Sheet**

PC35H13 V1 Product Specification

Product	White SMD LED
Part Number	PC35H13 V1
Issue Date	2018/03/22



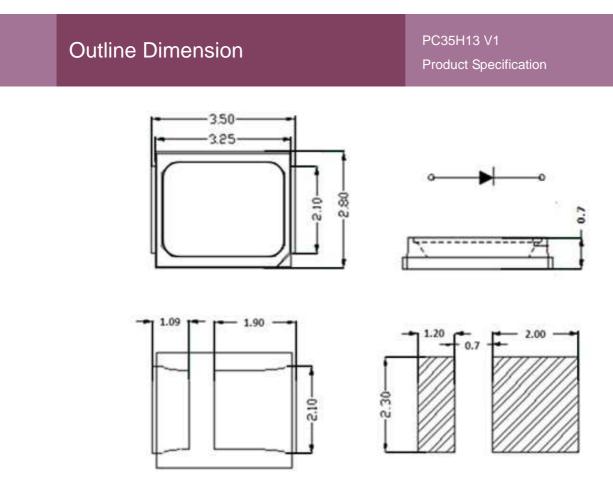
#### Feature

- ✓ White SMD LED (L x W x H) of 3.5x 2.8 x 0.7 mm
- ✓ ASNI Ellipse binning
- ✓ Dice Technology : InGaN
- ✓ Qualified according to JEDEC moisture sensitivity Level 3
- ✓ Environmental friendly ; RoHS compliance
- ✓ Packing : 2000 & 4000 pcs/reel

#### Applications

- ✓ Portable flashlight
- ✓ Reading lights
- ✓ Security / garden lighting
- ✓ General lighting
- Indoor and outdoor commercial lighting





- 1. Unit :mm
- 2. Tolerance : ±0.1mm



## Performance

#### PC35H13 V1

**Product Specification** 

#### ■ Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage <sup>(1)</sup>	V <sub>F</sub>		8.7	-	9.9	V
Color Rendering Index <sup>(2)</sup>	Ra	$L = 100 m \Lambda$	80	-	-	-
View Angle	θ	l <sub>F</sub> = 100 mA	-	120	-	deg
Thermal Resistance <sup>(3)</sup>	R <sub>th</sub>		-	15	-	°C/W

(1) The Forward Voltage tolerance is ±0.1V

(2) The Color Rendering Index tolerance is ±2

(3) Thermal resistance is calculated from junction to solder

#### ■ Luminous Flux (Ta=25°C)

ССТ	Condition	Rank		
2600K~3700K	100 m 4	UA,UB		
3700K~7000K	l <sub>F</sub> = 100 mA	VV,VW		

\* The luminous flux tolerance is  $\pm 7\%$ 

#### Absolute Maximum Ratings

Parameter	Symbol	value	Unit
DC Forward Current <sup>(1)</sup>	I <sub>F</sub>	120	mA
Power Dissipation	P <sub>D</sub>	0.96	W
Pulse Forward Current (2)	I <sub>FP</sub>	200	mA
Storage Temperature	T <sub>stg</sub>	-40 ~ 100	°C
Operating Temperature	T <sub>opr</sub>	-40 ~ 85	°C
Junction Temperature	TJ	125	°C
Assembly Temperature		260 (5 sec)	°C

(1) Proper current rating must be observed to maintain junction temperature below maximum at all time

(2) IFP Condition: Duty 1/10, Pulse within 10msec



PC35H131-A271Y0VUVUFI-000	U F I - 0 0 0
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								-															
- 4	2	2	А	5	6	7	9		0	10	4.4	12	12	14	15	16	17	10	10	20	21	22	22
	<b>_</b>	3		5	0	1	0		3	10		14	13	1.44	10	10	17	10	13	20	<b>∠</b> I		23

ltem		Pos.	Code	Spec		
Model Na	ame	1-8	PC35H131	PC35H13 V1		
CIE Center P	oint	9	А	ANSI 1931 on B.B.L		
ССТ		10,11	27 30 35 40 50 57 65	27 = 2700K 30 = 3000K 35 = 3500K 40 = 4000K 50 = 5000K 57 = 5700K 65 = 6500K		
R9		12	1	R9 > 0		
CIE Bin Grou	p <sup>(1)</sup>	13,14	Y0 Z0	275 275,27F,27G,27H,27I		
IV Bin Grou	р	15,16, 17,18	VUVU VUVV	Bin code : VU Bin code : VU,VV,		
Vf Bin Grou	р	19,20	GI	Bin code : F,G,H,I		
Kitting Rules	-		0 1 <sup>(2)</sup> 2 <sup>(2)</sup>	No requirements. 275+275 275+275,27F+27H,27G+27I		
	IV	22	0	No requirements.		
	Vf	23	0	No requirements.		

 The first two digits 27 means CCT in 2700K, can be replaced to 30, 35, 40, 50, 57, 65 for different CCT requirements.

(2) Only under an agreement between customer and Lextar Electronics, kitting rules besides "0" can be supplied.

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#### **Standard Ordering Code:**

ССТ	Ordering Code <sup>(1)</sup>	CIE Bin Group	IV Bin Group	Vf Bin Group	
2700K	PC35H131-A271Y0VUVUGI-000	Y0	VU	F,G,H,I	
27001	PC35H131-A271Z0VUVUGI-000	ZO	VO	F,G,H,I	
3000K	PC35H131-A301Y0VUVUGI-000	Y0	VU	ECHI	
3000K	PC35H131-A301Z0VUVUGI-000	ZO	VO	F,G,H,I	
3500K	PC35H131-A351Y0VUVUGI-000	Y0	VU	F,G,H,I	
5500K	PC35H131-A351Z0VUVUGI-000	ZO	VO	1,0,11,1	
4000K	PC35H131-A401Y0VUVVGI-000	Y0	VU,VV,	F,G,H,I	
4000K	PC35H131-A401Z0VUVVGI-000	ZO	v 0, v v,	F,G,H,I	
5000K	PC35H131-A501Y0VUVVGI-000	Y0	VU,VV,	F,G,H,I	
JUUUK	PC35H131-A501Z0VUVVGI-000	ZO	V U , V V,	г, С, П, І	
5700K	PC35H131-A571Y0VUVVGI-000	Y0			
9700K	PC35H131-A571Z0VUVVGI-000	ZO	VU,VV,	F,G,H,I	
6500K	PC35H131-A651Y0VUVVGI-000	Y0		ECHI	
AUUGO	PC35H131-A651Z0VUVVGI-000	ZO	VU,VV,	F,G,H,I	

 Only under an agreement between customer and Lextar Electronics, Ordering codes not in "Standard Ordering Code Definitions" can be supplied.

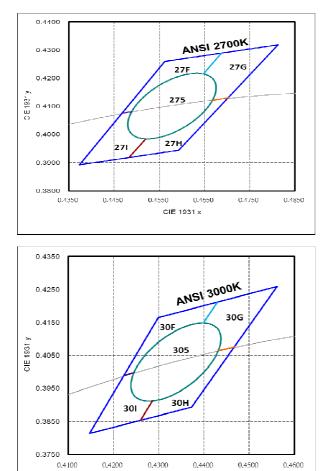


### Binning- ANSI Ellipse Binning

#### PC35H13 V1 Product Specification

#### Chromaticity Coordinates

PC35H13 is hot color targeted so that at 85°C, the color is within ANSI while typical bin structured at 85°C. In application conditions, the LED temperature rises and at 85°C the typical color bins will be as shown.



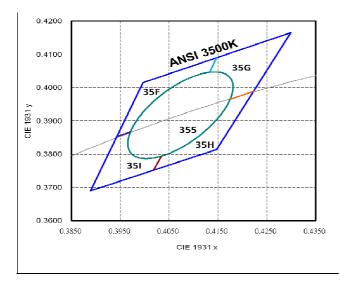
CIE 1931 x

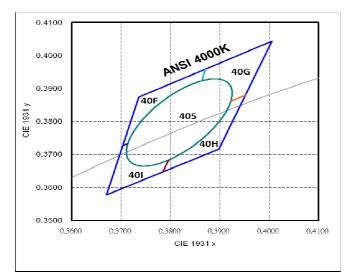
ССТ	Steps	Target Center F	Target Center Point (CIEx,CIEy)		B(Minor Axis)	Ellipse Rotation Angle	
2700K	5	0.4578	0.4101	0.0135	0.007	53.7	
3000K	5	0.4338	0.4030	0.0139	0.0068	53.22	

	CIE-X	CIE-Y		CIE-X	CIE-Y
2700K	0.4813	0.4319		0.4562	0.426
	0.4562	0.4260	2000K	0.4299	0.4165
	0.4373	0.3893	3000K	0.4147	0.3814
	0.4593	0.3944		0.4373	0.3893

No. 3, Gongye E. 3rd Road, Hsinchu Science Park, Hsinchu 30075, Taiwan TEL : 886-3-565-8800

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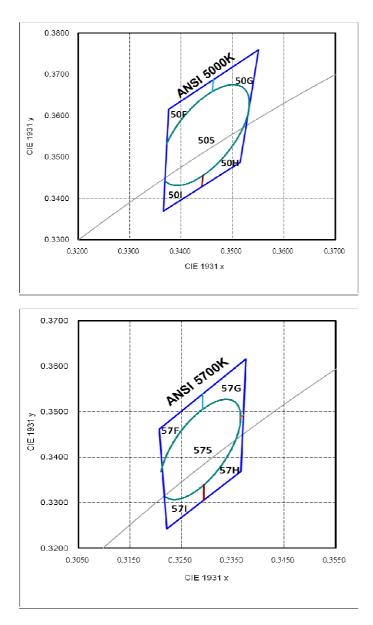


ССТ	Steps	Target Center Point (CIEx,CIEy)		A(Major Axis)	B(Minor Axis)	Ellipse Rotation Angle	
3500K	5	0.4073	0.3917	0.01545	0.0069	53.22	
4000K	5	0.3818	0.3797	0.01565	0.0067	53.72	

	CIE-X	CIE-Y		CIE-X	CIE-Y
3500K	0.4299	0.4165		0.4006	0.4044
	0.3996	0.4015	4000K	0.3736	0.3874
	0.3889	0.3690	4000K	0.3670	0.3578
	0.4147	0.3814		0.3898	0.3716

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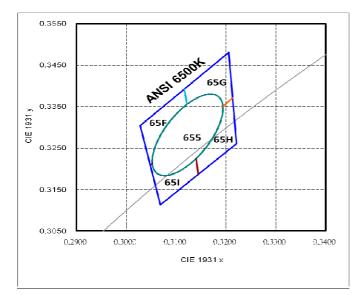
ССТ	Steps	Target Center Point (CIEx,CIEy)		A(Major Axis)	B(Minor Axis)	Ellipse Rotation Angle
5000K	5	0.3447	0.3553	0.0137	0.0059	59.62
5700K	5	0.3287	0.3417	0.0124	0.0053	59.09

	CIE-X	CIE-Y		CIE-X	CIE-Y
	0.3551	0.3760		0.3376	0.3616
50001/	0.3376	0.3616	5700K	0.3207	0.3462
5000K	0.3366	0.3369	5700K	0.3222	0.3243
	0.3515	0.3487		0.3366	0.3369

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ССТ	Steps	Target Center Point (CIEx,CIEy)		A(Major Axis)	B(Minor Axis)	Ellipse Rotation Angle	
6500K	5	0.3123	0.3282	0.01115	0.00475	58.57	

	CIE-X	CIE-Y
	0.3205	0.3481
6500K	0.3028	0.3304
NUUGO	0.3068	0.3113
	0.3221	0.3261

Note:

- (1) Correlated color temperature is derived from the CIE 1931chromaticity diagram
- (2) CIE measurement tolerance is  $\pm 0.005$



#### Bin code definition

V <sub>F</sub> Rank	Luminous Flux Rank	CIE Rank
G	VT	655

V <sub>F</sub> Rank	Condition	Min.	Max.	
F		8.7	9.0	
G	100 m 4	9.0	9.3	
Н	I <sub>F</sub> = 100 mA	9.3 9.6		
I		9.6	9.9	
Luminous Flux Rank	Condition	Min.	Max.	
UA		110	115	
UB	100 m 4	115	120	
VV	I <sub>F</sub> = 100 mA	120	130	
VW		130	140	

Note:

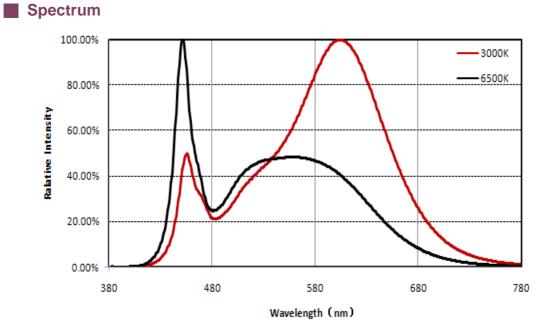
- (3) The luminous flux tolerance is  $\pm 7\%$
- (4) The Forward Voltage tolerance is ±0.1V



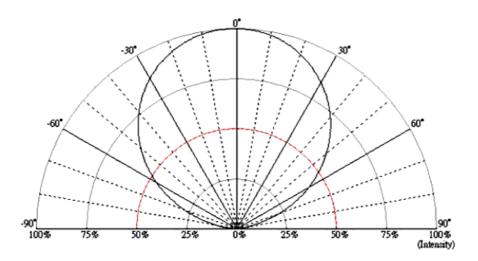
### Characteristics

PC35H13 V1

Product Specification

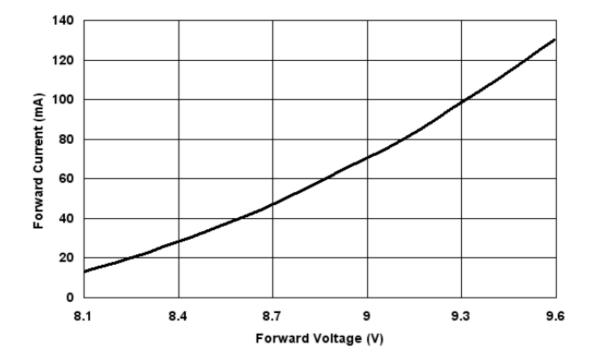




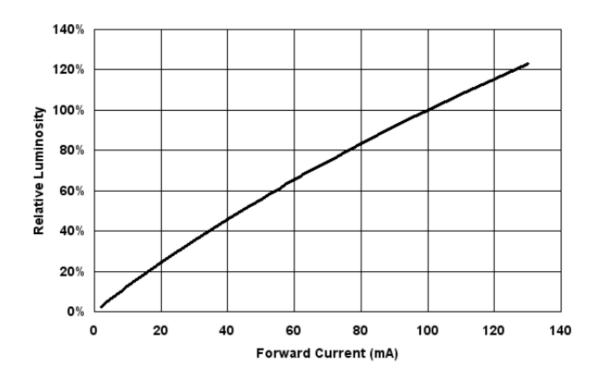




#### Forward Voltage vs. Forward Current



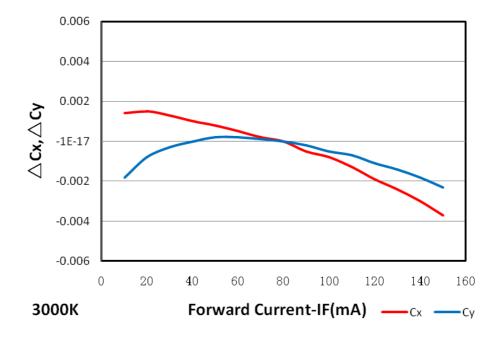
#### Forward Current vs. Relative Luminosity

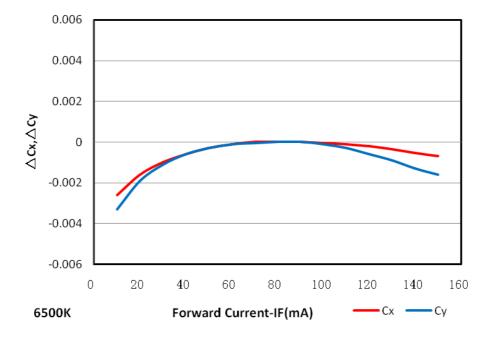


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#### Forward Current vs. Chromaticity Coordinate

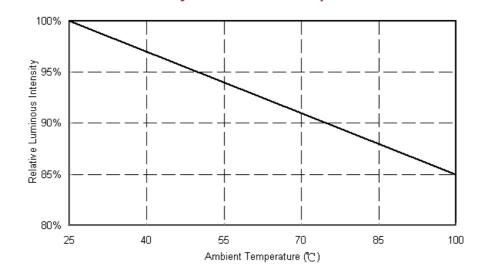




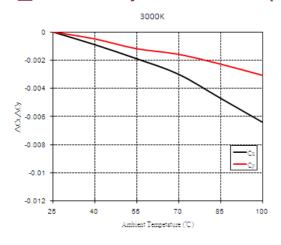
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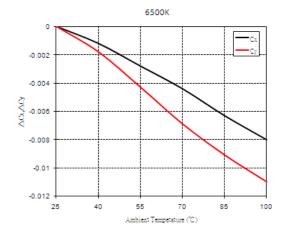


#### Relative Luminous Intensity vs. Ambient Temperature

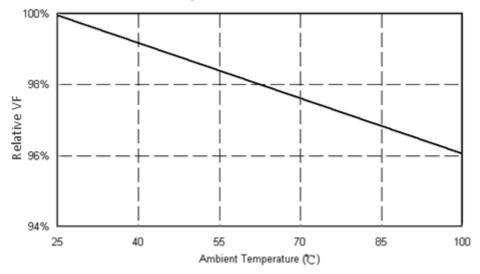


#### Chromaticity vs. Ambient Temperature





#### Relative VF vs. Ambient Temperature



## Reliability

#### PC35H13 V1

Product Specification

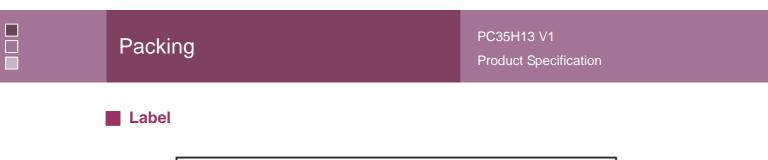
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Reliability test			
ltem	Condition	Time/Cycle	
Steady State Operating Life of Low	40°C Operating	1000 Hrs	
Temperature -40°C	-40°C Operating	1000 HIS	
Steady State Operating Life of High	60°C Operating	1000 Hrs	
Temperature 60°C	60°C Operating	1000 Hrs	
Steady State Operating Life of High	Ts 105 °C Operating	1000 Hrs	
Temperature Ts105°C	is tos c Operating		
Low temperature storage -40°C	-40°C Storage	1000 Hrs	
High temperature storage 100°C	100°C Storage	1000 Hrs	
Steady State Operating Life of High	60°C/00°/ Operating	1000 Hrs	
Humidity Heat 60°C90%	60°C/90% Operating	1000 HIS	
Resistance to soldering heat on PCB	pre-store@60°C, 60%RH for 52hrs	1 cycle	
(JEDEC MSL3)	Tsld max.=260°C 10sec	3 Times	
Thermal shock	-40°C/20minr ~5minr ~ 100°C/20min	100 Cycles	

### Judgment Criteria

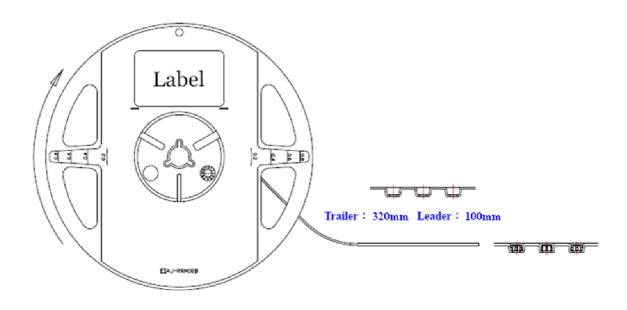
Item	Symbol	Test Condition	Judgment Criteria	
Forward Voltage	Vf	100mA	∆Vf < 10 %	
Luminous Flux	lv	100mA	∆lv < 30 %	



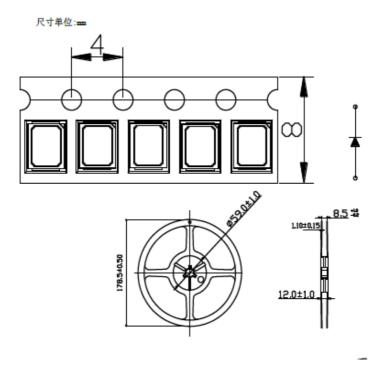




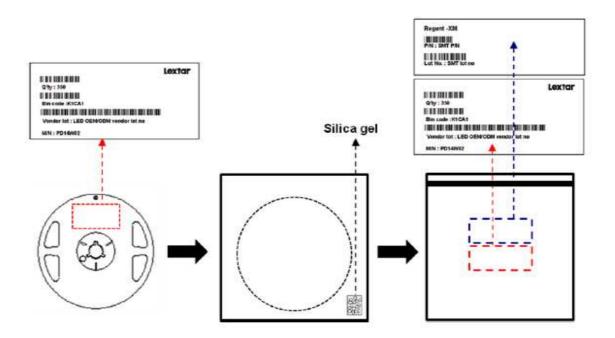
#### Carrier Taping







Shield Bag Taping



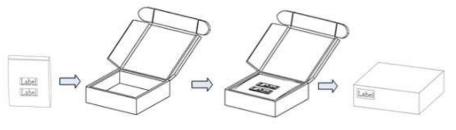
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#### Packing Box

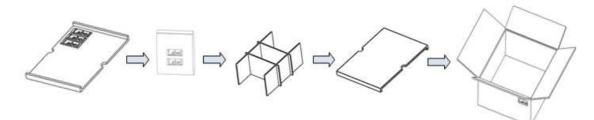
Туре	Large Box		Medium Box		Small Box		
Dimension	541X511X276ı	mm	385X303X260	mm	283X235	x70m	m
Maximum Reels	7"X12mm Reel	64/R	7"X12mm Reel	21/R	7"X12mm	Reel	4/R
Minimum Reels	7"X12mm Reel	32/R	7"X12mm Reel	9/R	7"X12mm	Reel	1/R

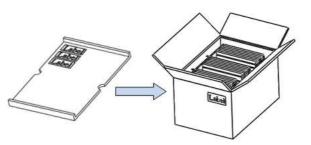
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#### Small Box

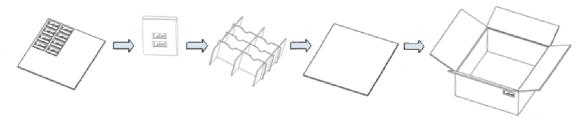


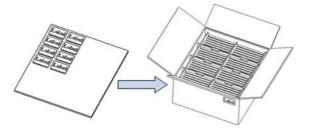
#### Medium Box













### Precautions

PC35H13 V1 Product Specification

#### Safety Precautions

- The LED light output is too strong for human eyes without shield. Prevent eye contact directly more than seconds.
- Ensure operating under maximum rating.

#### Storage

- Before opening the package, the LEDs should storage under 30°C, 60% RH.
- After opening the package bag, the LEDs should be keep under 30°C, 60% RH.
  Recommend to use within 168hrs. If unused LEDs remain, suggest to store into moisture proof bag or original package bag with moisture absorbent material such as silica gel.
  Reseal well is necessary.
- If the product exceeded the storage period or the moisture absorbent material faded away, baking treatment should be done by following conditions.
   Bake condition: 60°C, 12hours (One time only).

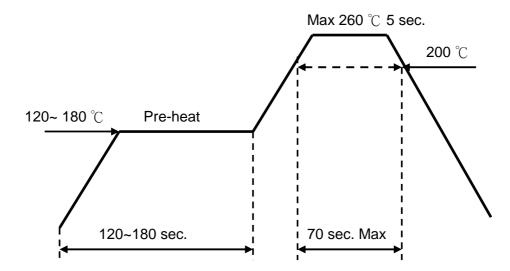
#### Soldering Notice and Conditions

- When soldering LEDs,
- Do not solder/reflow the same LED over two times.
- Recommend soldering conditions:
  Hand soldering: 350 °C max , 3 sec. max.

Reflow soldering: Pre-heat 180 °C max , 180 sec. max.

Peak 260  $^\circ\!\mathrm{C}$  max , 5 sec. max.

• Reflow temperature profile as below: (lead-free solder)





- When soldering, don't put stress on the LEDs
- After LEDs have been soldered, strongly recommend not to repair to keep the LEDs performance.

#### Static Electricity

- LED package is extremely sensitive to static electricity. It's recommended that anti-electrostatic glove and wrist band is necessary when handling the LEDs. All devices are also be grounded properly as well.
- Protection devices design should be considered in the LED driving circuit.

#### Cleaning

- If washing is required, recommend to use alcohol as a solvent.
- Recommend to avoid cleaning the LEDs by ultrasonic. If necessary, pre-test the LED is necessary to confirm whether any damage occur after the process.



## **Revision History**

#### PC35H13 V1

**Product Specification** 

Date	Contents	Writer
2017.03.20	Release	Kenis Hung
2017.08.02	Luminous Flux Rank	Josh Yang
2018.01.04	Add VF Rank	Josh Yang
2018.03.22	Modify VF Rank / Maximum Ratings	Josh Yang

## Smart Lighting Amazing Life

Lextar Electronics Corp. is the leading LED (Light Emitting Diode)

maker integrating upper stream epitaxial, middle stream chip, and downstream package,

SMT and LED lighting applications. Founded in May, 2008, Lextar is a subsidiary of AU Optronics,

the leading TFT-LCD and solar PV manufacturer. Lextar's product applications include lighting and LCD backlight.

Lextar's manufacturing sites include Hsinchu and Chunan in Taiwan, and Suzhou in China. Copyright ©2010 Lextar Electronics Corporation. All rights reserved. Lextar.com The company turnover in 2012 is 340 million USD. 单击下面可查看定价,库存,交付和生命周期等信息

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